

# COM Express® Compact Type 6 Module

## conga-TCA

COM Express Type 6 Entry-Level-Module

Intel® Atom™ Dual Core Generation on 32nm

Only 3.5 Watt TDP on Intel® Atom™ Processor N2600

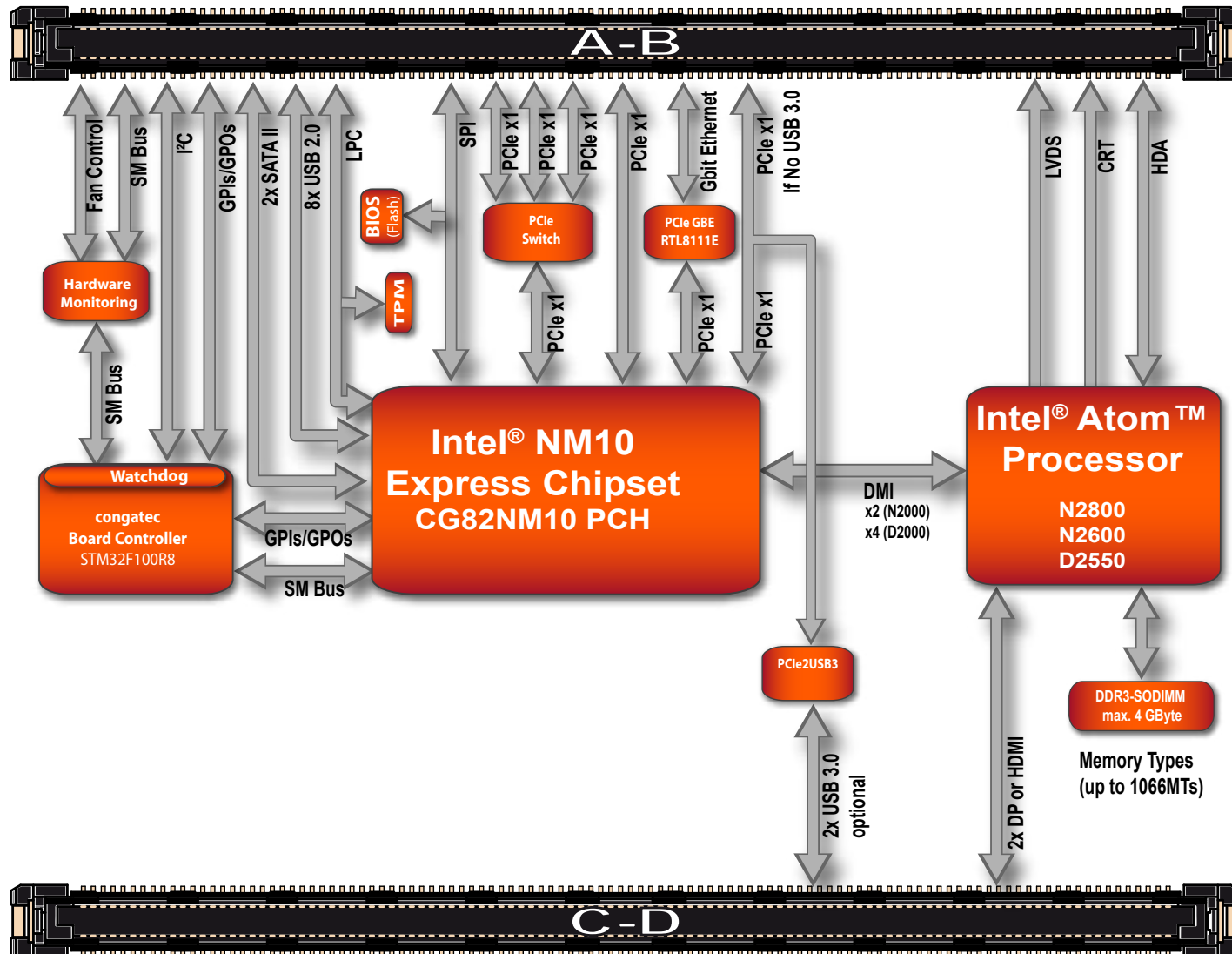
HD video performance 2D/3D

Up to 4 GB DDR3 memory



Formfactor	Formfactor COM Express™ Compact, (95 x 95 mm), Type 6 Connector Layout
CPU	Intel® Atom™ D2550, 2 cores, 4 threads, 1.86GHz, 1MB L2 Cache, TDP 10W Intel® Atom™ N2800, 2 cores, 4 threads, 1.86GHz, 1MB L2 Cache, TDP 6.5W Intel® Atom™ N2600, 2 cores, 4 threads, 1.6GHz, 1MB L2 Cache, TDP 3.5W
DRAM	1 Socket SO-DIMM DDR3 up to 1066MT/s and 4 GByte
Chipset	Intel® NM10 Express Chipset CG82NM10 PCH, TDP 2.1W
Ethernet	GBE Realtek 8111E
I/O Interfaces	up to 5x PCIe, 2x Serial ATA II with 3 Gb/s 8x USB 2.0, 2x USB 3.0 (optional, uses 1x PCIe lane), LPC bus, I²C bus (fast mode, 400 kHz, multi-master)
Sound	Digital High Definition Audio Interface with support for multiple audio codecs
Graphics	Integrated Grapics, supporting DirectX 9, Pixel Shader v3.0 and OGL 3.0 Two independent display pipes Support full MPEG2 (VLD/iDCT/MC), WMV, Fast video Composing, HW decode/acceleration for MPEG4 (AVC/H.264) & VC-1; 720p60, 1080i60, 1080p@24 up to 20 Mps Video Image enhancements
LVDS	1x24 Bit LVDS (D2550) max. Resolution 1440x900 1x18 Bit LVDS (N2000 Series) max. Resolution 1366x768 Automatic Panel Detection via EDID/EPI
Digital Display Interface (DDI)	2x DisplayPort 1.1 / TMDS (DVI, HDMI 1.3a)
CRT Interface	350 MHz RAMDAC, resolutions up to 1920x1200
congatec Board Controller	Multi Stage Watchdog, non-volatile User Data Storage, Manufacturing and Board Information, Board Statistics, BIOS Setup Data Backup, I²C bus (fast mode, 400 kHz, multi-master), Power Loss Control
Embedded BIOS Features	AMI Aptio® UEFI 2.x firmware, 4 MByte serial SPI firmware flash
Security	Trusted Platform Module (TPM) optional. Hash and RSA algorithms, key lengths up to 2,048 bits, real random number generator
Power Management	ACPI 3.0 with battery support
Operating Systems	Microsoft® Windows 8, Microsoft® Windows 7, Linux, Microsoft® Windows® embedded Standard
Power Consumption	Typ. application: tbd., see manual for full details, CMOS Battery Backup
Temperature:	Operating: 0 .. +60°C Storage: -20 .. +80°C
Humidity Operating:	Operating: 10 - 90% r. H. non cond. Storage: 5 - 95% r. H. non cond.
Size	95 x 95 mm (3.74" x 3.74")

# conga-TCA - Block diagram



# conga-TCA - Order information

Article	PN	Description
conga-TCA/D2550	047003	COM Express Type 6 Compact modul with Intel® Atom™ D2550 Dual Core Processor with 1.86 GHz and 1MB L2 cache.
conga-TCA/D2550 USB3	047004	COM Express Type 6 Compact modul with Intel® Atom™ D2550 Dual Core Processor with 1.8GHz, 1MB L2 cache and PCIe to 2x USB 3.0 Controller onboard
conga-TCA/N2600	047001	COM Express Type 6 Compact modul with Intel® Atom™ N2600 Dual Core Processor with 1.6GHz and 1MB L2 cache.
conga-TCA/N2800	047002	COM Express Type 6 Compact modul with Intel® Atom™ N2800 Dual Core Processor with 1.86GHz and 1MB L2 cache.
conga-TCA/HSP-T	047032	Standard heatspreader for COM Express modules conga-TCA and CCA. All standoffs are M2.5 thread.
conga-TCA/HSP-B	047033	Standard heatspreader for COM Express modules conga-TCA and CCA. All standoffs are 2.7mm bore hole.
conga-TCA/CSP-T	047030	Standard passive cooling solution for COM Express modules conga-TCA and CCA with 3mm fins. All standoffs are M2.5mm thread.
conga-TCA/CSP-B	047031	Standard passive cooling solution for COM Express modules conga-TCA and CCA with 3mm fins. All standoffs are with 2.7mm bore hole.

Engineering Tools / Accessories for COM Express®		
conga-TEVAL	065800	Evaluation carrier board for Type 6 COM-Express-modules
conga-LDVI/EPI	011115	LVDS to DVI converter board for digital flat panels with onboard EEPROM
COM-Express-carrierboard-Socket-5	400007	Connector for COM-Express carrier boards, height 5mm, packing unit 4 pieces
COM-Express-carrierboard-Socket-8	400004	Connector for COM-Express carrier boards, height 8mm, packing unit 4 pieces
MGCA	xxxxxxx	xxxxxx

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